Form PTO-1595 RECORDATION FORM CO (Rev. 03/ 01) OMB No. 0651-0027 (exp. 5/31/2002)	VER SHEET U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office	
To the Honorable Commissioner of Patents and Trademarks: P	lease record the attached original documents or copy thereof	
Name of conveying party(ies):	Name and address of receiving party(ies)	
Dae Han KWON	Name: Hynix Semiconductor Inc.	
	Internal Address:	
Additional name(s) of conveying party(ies) Stached? Yes X No	Street Address: San 136-1, Ami-Ri Bubal-Uep, Ichon-Shi	
3. Nature of Conveyance:		
X Assignment Merger		
Security Agreement Change of Name	City: Kyungki-do	
Other	Country: Republic of Korea Zip:	
Execution Date: October 29, 2004	Additional name(s) & Yes X No address(es) attached:	
Application number(s) or patent number(s):		
If this document is being filed together with a new application, the ex A. Patent Application No.(s): 11/008,043 Filed 12/9/2004	ecution date of the new application is: B. Patent No.(s):	
Additional numbers attache	ed? Yes X No	
Name and address of party to whom correspondence concerning document should be mailed;	6. Total number of applications and 1 patents involved:	
Name: Aaron M. Peters		
MARSHALL, GERSTEIN & BORUN LLP	40.00 7. Total fee (37 CFR 3.41) \$	
Internal Address: Atty. Dkt.: 29936/40734	Enclosed	
Street Address:		
233 S. Wacker Drive, Suite 6300	X Authorized to be charged to deposit account	
Sears Tower	Authorized to be charged to credit card (Form 2038 enclosed)	
Citus States 7ie.	Deposit account number:	
City: State: Zip: Chicago IL 60606-6357	13-2855 (Aftach duplicate copy of this page if paying by deposit account)	
DO NOT USE THIS SPACE	(the second sec	
9. Statement and signature.		
To the best of my knowledge and belief, the foregoing info is a true copy of the original document.	ormation is true and correct and any attached copy	
Date : February 24, 2005	Aaron M. Peters	
Total number of pages including cover sheet, attachments, and documents; 3		

ASSIGNMENT

Serial No:

2/24/2005 03:28:42 PM

11/008,043

Filed:

December 9, 2004

Title:

ON DIE TERMINATION CIRCUIT

For \$10.00 (Ten Dollars) and other good and sufficient consideration, the receipt and sufficiency whereof are hereby acknowledged, the undersigned hereby assign to Hynix Semiconductor Inc., of San 136-1, Ami-Ri, Bubal-Uep, Ichon-Shi, Kyungki-Do, Republic of Korea, (hereinafter "Assignee"), its successors and assigns, the entire right, title and interest in the invention or improvements of the undersigned disclosed in an application for Letters Patent of the United States, executed by the undersigned on, and in said application and any and all other applications, both United States and foreign, which the undersigned may file, either solely or jointly with others, on said invention or improvements, and in any and all Letters Patent of the United States and foreign countries, which may be obtained on any of said applications, and in any reissue or extension thereof.

The undersigned hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to said assignee.

The undersigned hereby authorize and request the attorneys of record in said application to insert in this assignment the execution date and/or filing date and serial number of said application when officially known.

The undersigned warrant themselves to be the owners of the interest herein assigned and to have the right to make this assignment and further warrant that there are no outstanding prior assignments, licenses, or other rights in the interest herein assigned.

For said consideration the undersigned hereby agree, upon the request and at the expense of said assignee, its successors and assigns, to execute any and all divisional, continuation, continuation-in-part and substitute applications for said invention or improvements, and any necessary oath or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon said application, and any and all applications and other documents for Letters Patent in foreign countries on said invention or improvements, that said assignee, its successors or assigns, may deem necessary or expedient, and for the aforesaid consideration the undersigned further agree upon the request of said assignee, its successors or assigns, in the event of any application or Letters Patent assigned herein becoming involved in Interference, to cooperate to the best of the ability of the undersigned with said assignee, its successors or assigns, in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof, the undersigned hereby agreeing to perform, upon request, any and all affirmative acts to obtain said Letters Patent, both United States and foreign, and vest all rights therein hereby conveyed in said assignee, its successors and assigns, whereby said Letters Patent will be held and enjoyed by said assignee, its successors and assigns, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

PATENT REEL: 015786 FRAME: 0736

Date:	October 29, 2004	Signature:	Name: Dae Han KWON
Date:		Signature:	
Date:		Signature:	